Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
Li	2	("6459160").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/02/15 10:30
L2	2	("20030061693").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/02/15 10:30
L3	2	("6770885").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/02/15 10:30
L4	2	("6046074").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/02/15 10:42
L5	6	agilent.as. and (chip or die) and substrate and (hermetic or hermetically) and (caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and (bonding adj agent or metal or "au" or gold)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/15 10:46
L6	1	fazzio.as. and (chip or die) and substrate and (hermetic or hermetically) and (caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and (bonding adj agent or metal or "au" or gold)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/15 10:46
L7	2	fazzio.in. and (chip or die) and substrate and (hermetic or hermetically) and (caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and (bonding adj agent or metal or "au" or gold)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/15 10:46
S1	66	257/704.ccls. and device adj chip	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/13 10:41
S2	61	257/704.ccls. and (chip or die) and substrate and (hermetic or hermetically) and (caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and (bonding adj agent or metal or "au" or gold)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/15 10:44

S3	5	("4684763" "5270571" "5821175" "6168947" "6281573").PN. OR ("6836013").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 13:33
S4	6	("4736128" "5608362" "5920242" "5939956" "6157076").PN. OR ("6794958").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 13:35
S5	89	("3619233" "3638076" "3770404" "3936864" "3957538" "4094514" "4142203" "4212349" "4261584" "4291815" "4294729" "4313492" "4401766" "4410647" "4411680" "4463315" "4471259" "4603345" "4610934" "4657337" "4722586" "4746583" "4764846" "4806704" "4824123" "4830264" "4871108" "5001546" "5016138" "5032788" "5132185" "5134461" "5139972" "5183269" "5188280" "5229727" "5247779" "5276455" "5280413" "5302219" "5311059" "5311402" "5325265" "5336928" "5337588" "5360988" "5371404" "5378313" "5413489" "5498900" "5506448"). PN. OR ("5744752").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 14:14
S6	43	("3693239" "3760090" "3872583" "4012832" "4023562" "4067955" "4264917" "4331258" "4539622" "4560826" "4631820" "4633573" "4640436" "4672151" "4925024" "4959900" "5027191" "5043533" "5049978" "5070041" "5071712" "5091770").PN. OR ("5280413").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 14:16
S7	1608	(chip or die) and substrate and (hermetic or hermetically) and (caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and (bonding adj agent or metal or "au" or gold) and (cap or lid or cover)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/10 15:20
S8	5	("4684763" "5270571" "5821175" "6168947" "6281573").PN. OR ("6836013").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 14:56
S9	6	("4736128" "5608362" "5920242" "5939956" "6157076").PN. OR ("6794958").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 14:57
S10	28	("4141055" "4480009" "4783697"). PN. OR ("5117279").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 15:12

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S11	1985	(seal or sealed or bond or bonded or adhere or adhesive) near5 (caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and (seal or sealed or bond or bonded or adhere or adhesive) near5 (bonding adj agent or metal or "au" or gold) and (cap or lid or cover)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/14 11:59
S12	241	257/781.ccls. and (caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and (bonding adj agent or metal or "au" or gold or conductive)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/10 16:32
S13	52	257/710.ccls. and (caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and (bonding adj agent or metal or "au" or gold or conductive)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/10 16:41
S14	2	("5201456").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/02/10 16:41
S15	7	("3020182" "4338380" "4704626"). PN. OR ("5201456").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 16:43
S16	649	(seal or sealed or bond or bonded or adhere or adhesive) near5 (caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and gasket and (cap or lid or cover)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/10 19:11
S17	8	("3279643" "3380610").PN. OR ("3578203").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 18:47
S18	7	("4091083" "4795166" "5128209" "5172920" "5362074" "5509993" "5618050").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 18:54
S19	6	("4736128" "5608362" "5920242" "5939956" "6157076").PN. OR ("6794958").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 19:07
S20	4	("4684763" "5270571" "6168948" "6281573").PN. OR ("6919222").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/10 19:09
S21	158	gasket near5 (cap or lid or cover) and "257"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/13 10:41

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S22	25	gasket near5 (cap or lid or cover) and substrate and semiconductor and resonator	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/13 11:33
S23	367	gasket near5 (cap or lid or cover) and substrate and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/14 11:43
S24	25	gasket near5 (cap or lid or cover) and substrate and semiconductor and resonator	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/14 13:33
S25	686	(caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and gasket near5 (cap or lid or cover)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/14 12:01
S26	86	(caulk or caulking or amorphous adj fluorocarbon or polyimide or benzocyclobutene) and gasket near5 (cap or lid or cover) and substrate and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/14 12:01
S27	1430	(chip or die) same resonator and substrate and semiconductor	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/14 13:37
S28	768	(chip or die) same resonator and substrate and semiconductor and (cover or lid or cap)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/14 14:18
S29	2	"6459160".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/14 14:18
S30	10	("4315591" "5059553" "5069978" "5201456" "5881945" "5931222" "6046074" "6107109").PN. OR ("6459160").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/14 14:19

S31	56	("3107756" "3619233" "3638076" "3770404" "3936864" "3946190" "3957538" "4094514" "4142203" "4212349" "4261584" "4291815" "4294729" "4313492" "4356047" "4401766" "4410647" "4411680" "4463315" "4471259" "4601958" "4603345" "4610934" "4657337" "4722586" "4746583" "4750665" "4764846" "4806704" "4824123" "4830264" "4871108" "5001546" "5016138" "5032788" "5132185" "5134461" "5139972" "5183269" "5188280" "5229727" "5247779" "5276455" "5280413" "5302219" "5378313" "5447886" "5616520" "5744752" "5945735").PN. OR ("6046074").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/14 14:19
S32	15	("4020987" "4656499" "4827082" "4985753" "5138426" "5159432" "5463248").PN. OR ("5945735").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2006/02/14 15:17
S33	0	"6046074".pn. and resonator	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2006/02/14 15:17